AUG 0 3 2007

Docket No. 251598US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yukio HOSAKA, et al.

SERIAL NO: 10/820,123

GAU: 3723

FILED:

April 8, 2004

EXAMINER: RACHUBA, MAURINA T.

FOR:

ABRASIVE PAD, METHOD AND METAL MOLD FOR MANUFACTURING THE SAME, AND

SEMICONDUCTOR WAFER POLISHING METHOD

REQUEST FOR EXTENSION OF TIME UNDER 37 C.F.R. 1.136

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

It is	s hereby requested that a one month extension of time be granted to August 12, 2007 for
	filing a response to the Official Action dated:
	responding to the requirements in the Notice of Allowability dated:
	filing the Formal Drawings. The Issue Fee due has been timely filed.
	responding to the Notice to File Missing Parts of Application dated:
	filing a Notice of Appeal. A timely response to the final rejection, due July 12, 2007 has been filed. RCE in lieu of a Notice of Appeal is being filed herewith.
	filing an Appeal Brief. A Notice of Appeal was filed on:
	Applicant claims small entity status. See 37 CFR 1.27. Therefore, the fee amount shown below is reduced by one-half.
	e required fee of \$120.00 is enclosed herewith by credit card payment and any further charges may be made agains Attorney of Record's Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully Submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

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